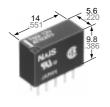


**ULTRA-SLIM** POLARIZED RELAY



ΤN



# UL File No.: E43149 CSA File No.: LR26550

- Ultra-slim size for minimal PC board mounting requirements
- Small header area makes higher density mounting possible
- High sensitivity: 140 mW nominal operating power (single side stable 3-12 V type)
- Surge voltage withstand: 1500 V FCC Part 68
- · Sealed construction allows automatic cleaning
- · Self-clinching terminal also available

# SPECIFICATIONS

Contact					
Arrangement			2 Form C		
Initial contact resistance, max. (By voltage drop 6 V DC 1A)			60 mΩ		
Contact material			Gold-clad silver		
Rating	Nominal s (resistive	witching capacity load)	1 A 30 V DC, 0.5 A 125 V AC		
	Max. swite (resistive	ching power load)	30 W, 62.5 VA		
-	Max. swite	ching voltage	110 V DC, 125 V AC		
	Max. swite	ching current	1 A		
	Min. switc	hing capability	10 µA 10 mV DC		
Nominal operating power	Single sic	le stable	140 mW (3 to 12 V DC) 200 mW (24 V DC) 300 mW (48 V DC)		
	1 coil latc	hing	100 mW (3 to 12 V DC) 150 mW (24 V DC)		
	2 coil latc	hing	200 mW (3 to 12 V DC) 300 mW (24 V DC)		
UL/CSA ra	ating		1 A 30 V DC 0.3 A 110 V DC 0.5 A 125 V AC		
Expected life (min. opera- tions)	Mechanic	al (at 180 cpm)	108		
	Electrical (at 20 cpm)	1 A 30 V DC resistive load	2×10 <sup>5</sup>		
		0.5 A 125 V AC resistive load	10⁵		

mm inch

#### **Characteristics**

Initial insula	ation resista	nce*1	Min. 1,000 MΩ (at 500 V DC)		
Initial breakdown voltage* <sup>2</sup>	Between op	pen contacts	750 Vrms for 1min.		
	Between co	ontact and coil	1,000 Vrms for 1min.		
	Between co	ontact sets	1,000 Vrms for 1min.		
FCC surge open conta	voltage betv cts	ween	1,500 V		
	ne [Set time] at nominal vo		Max. 3 ms (Approx. 2 ms) [Max. 3 ms (Approx. 2 ms)]		
Release time (without diode)[Reset time]*3 (at 20°C)(at nominal voltage)			Max. 3 ms (Approx. 1 ms) [Max. 3 ms (Approx. 2 ms)]		
Temperature rise*4 (at 20°C)			Max. 50°C		
Shock resistance		Functional*5	Min. 490 m/s <sup>2</sup> {50 G}		
		Destructive*6	Min. 980 m/s <sup>2</sup> {100 G}		
Vibration resistance		Functional*7	176.4 m/s <sup>2</sup> {18 G}, 10 to 55 Hz at double amplitude of 3 mm		
		Destructive	294 m/s <sup>2</sup> {30 G}, 10 to 55 Hz at double amplitude of 5 mm		
Conditions for transport and		Ambient temperature	<b>−40°C to +70°C</b> −40°F to +158°F		
(Not freezing a at low tempera	nd condensing ture)	Humidity	5 to 85% R.H.		
Unit weight			Approx. 1.5 g .053 oz		

#### Remarks:

Measurement at same location as "Initial breakdown voltage" section.

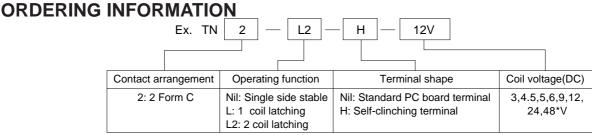
\*<sup>2</sup> Detection current: 10mA

\*3 Excluding contact bounce time.

- \*4 By resistive method; nominal voltage applied to the coil; contact carrying current: 1 A.
- <sup>45</sup> Half-wave pulse of sine wave: 11 ms; detection time: 10 μs
   <sup>46</sup> Half-wave pulse of sine wave: 6 ms

\*<sup>7</sup> Detection time: 10 μs

\*8 Refer to 4. Conditions for operation, transport and storage mentioned in Cautions for use (Page 108)



<sup>\*48</sup> V coil type: Single side stable only

Note: AgPd stationary contact types available for high resistance against contact sticking. When ordering, please add suffix "-3" like TN2-12V-3.

# TYPES AND COIL DATA (at 20°C 68°F)

Operating function	Part No.		Nominal	Pick-up	Drop-out	Nominal	Coil	Nominal	Max.
	Standard PC board terminal	Self-clinching terminal	voltage, V DC	voltage, V DC (max.)	voltage, V DC (min.)	operating current, mA (±10%)	resistance, $\Omega$ (±10%)	operating power, mW	allowable voltage, V DC
Single side stable	TN2-3 V	TN2-H-3 V	3	2.25	0.3	46.7	64.3	140	4.5
	TN2-4.5 V	TN2-H-4.5 V	4.5	3.38	0.45	31.1	145	140	6.7
	TN2-5 V	TN2-H-5 V	5	3.75	0.5	28.1	178	140	7.5
	TN2-6 V	TN2-H-6 V	6	4.5	0.6	23.3	257	140	9
	TN2-9 V	TN2-H-9 V	9	6.75	0.9	15.5	579	140	13.5
	TN2-12 V	TN2-H-12 V	12	9	1.2	11.7	1,028	140	18
	TN2-24 V	TN2-H-24 V	24	18	2.4	8.3	2,880	200	36
	TN2-48 V	TN2-H-48 V	48	36	4.8	6.25	7,680	300	57.6

Operating function	Part No.		Nominal		Reset	Nominal	Coil	Nominal	Max.
	Standard PC board terminal	Self-clinching terminal	voltage, V DC	Set voltage, V DC (max.)	voltogo	operating current, mA (±10%)	resistance, $\Omega$ (±10%)	operating power, mW	allowable voltage, V DC
1 coil latching	TN2-L-3 V	TN2-L-H-3 V	3	2.25	2.25	33.3	90	100	4.5
	TN2-L-4.5 V	TN2-L-H-4.5 V	4.5	3.38	3.38	22.2	203	100	6.7
	TN2-L-5 V	TN2-L-H-5 V	5	3.75	3.75	20	250	100	7.5
	TN2-L-6 V	TN2-L-H-6 V	6	4.5	4.5	16.7	360	100	9
	TN2-L-9 V	TN2-L-H-9 V	9	6.75	6.75	11.1	810	100	13.5
	TN2-L-12 V	TN2-L-H-12 V	12	9	9	8.3	1,440	100	18
	TN2-L-24 V	TN2-L-H-24 V	24	18	18	6.3	3,840	150	36
2 coil latching	TN2-L2-3 V	TN2-L2-H-3 V	3	2.25	2.25	66.7	45	200	4.5
	TN2-L2-4.5 V	TN2-L2-H-4.5 V	4.5	3.38	3.38	44.4	101	200	6.7
	TN2-L2-5 V	TN2-L2-H-5 V	5	3.75	3.75	40	125	200	7.5
	TN2-L2-6 V	TN2-L2-H-6 V	6	4.5	4.5	33.3	180	200	9
	TN2-L2-9 V	TN2-L2-H-9 V	9	6.75	6.75	22.2	405	200	13.5
	TN2-L2-12 V	TN2-L2-H-12 V	12	9	9	16.7	720	200	18
	TN2-L2-24 V	TN2-L2-H-24 V	24	18	18	12.5	1,920	300	28.8

Notes: 1. Specified value of the pick-up, drop-out, set and reset voltage is with the condition of square wave coil pulse.

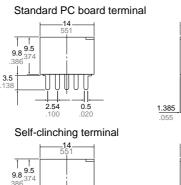
2. Standard packing: Tube: 50 pcs.; Case: 1,000 pcs.

**3.5** 

3. In case of 5 V drive circuit, it is recommended to use 4.5 V type relay.

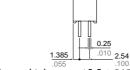
# DIMENSIONS





0.5 .020

2.54

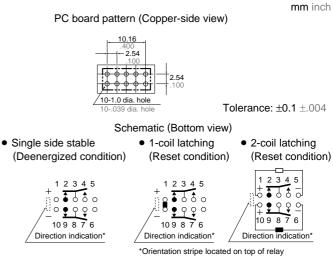


0.25

2.54

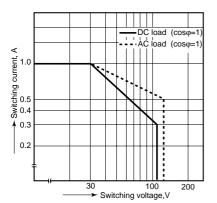
5.6

General tolerance:±0.3 ±.012

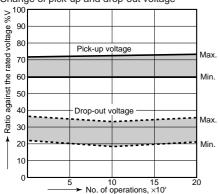


# **REFERENCE DATA**

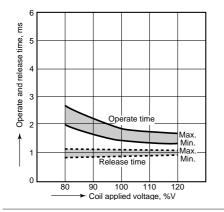
1. Maximum switching capacity



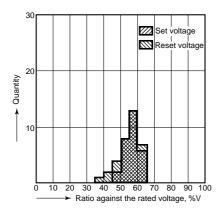
4. Electrical life (DC load) Tested sample: TN2-12V, 10 pcs. Condition: 1 A 30 V DC resistive load, 20 cpm Change of pick-up and drop-out voltage



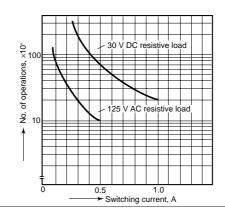
#### 6. Operate / release time characteristics Tested sample: TN2-12V, 5 pcs.



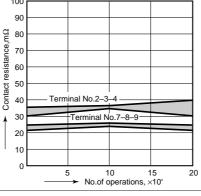
9. Distribution of set and reset voltage Tested sample: TN2-L2-12V, 32 pcs.



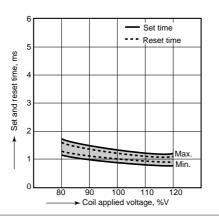




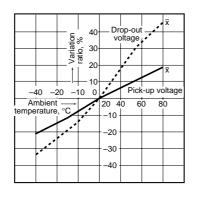
#### Change of contact resistance 100

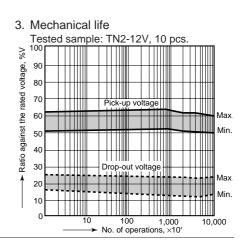


7. Set / reset time characteristics Tested sample: TN2-L2-12V, 5 pcs.

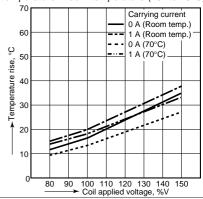


10. Ambient temperature characteristics Tested sample: TN2-12V, 5 pcs.

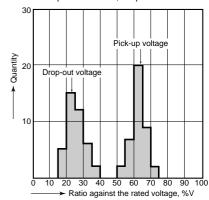




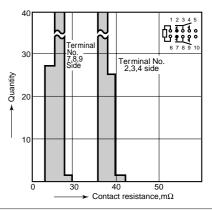
5. Coil temperature rise Tested sample: TN2-12V Point measured: Inside the coilAmbient temperature: Room temperature (25° to 26°C),

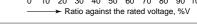


8. Distribution of pick-up and drop-out voltages Tested sample: TN2-12V, 40 pcs.



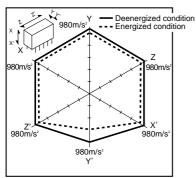
11. Distribution of contact resistance Tested sample: TN2-12V, 38 pcs. (38×4 contacts)



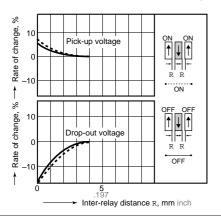


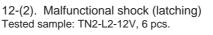
12-(1). Malfunctional shock (single side stable)

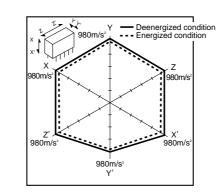
Tested sample: TN2-12V, 6 pcs.



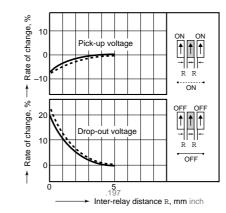
13-(1). Influence of adjacent mounting



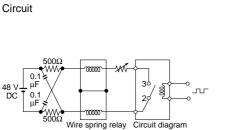


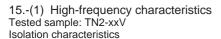


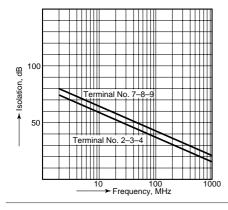
13-(2). Influence of adjacent mounting

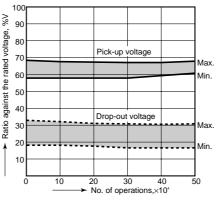


14. Actual load test (35 mA 48V DC wire spring relay load)

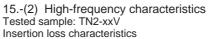


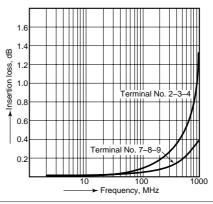




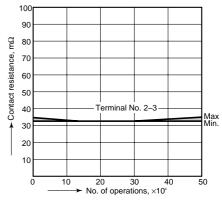


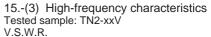
Change of pick-up and drop-out voltage

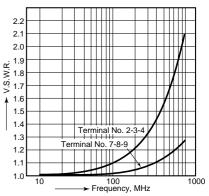












# NOTES

# 1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%. However, check it with the actual circuit since the characteristics may be slightly different. The nominal operating voltage should be applied to the coil for more than 10 ms to set/reset the latching type relay.

### 2. Coil connection

When connecting coils, refer to the wiring diagram to prevent mis-operation or malfunction.

### 3. External magnetic field

Since T-Series relays are highly sensitive polarized relays, their characteristics will be affected by a strong external magnetic field. Avoid using the relay under that conditions.

### 4. Conditions for operation, transport and storage

1) Ambient temperature, humidity, and atmospheric pressure during usage, transport, and storage of the relay:

# TX(-SMD)/TX-D(-SMD)/TQ-SMD

(1) Temperature:

-40 to +85°C -40 to +185°F.

The temperature range is -40 to +70°C -40 to +158°F for the

packaged relay.

### TX-S(-SMD)

(1) Temperature: -40 to +70°C -40 to +158°F.

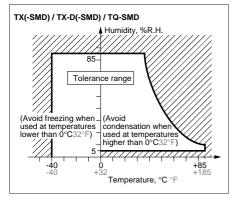
#### for the package/non-package relay. TQ/TF/TN/TK

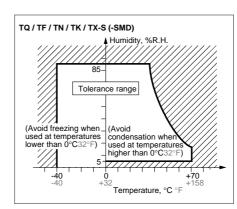
(1) Temperature: -40 to +70°C -40 to +158°F

The temperature range is -40 to +60°C -40 to +140°F for the packaged relay. (2) Humidity: 5 to 85% R.H. (Avoid freezing and condensation.) The humidity range varies with the temperature. Use within the range indicated in the graph below.

(3) Atmospheric pressure: 86 to 106 kPa

#### Temperature and humidity range for usage, transport, and storage:





### 2) Condensation

Condensation forms when there is a sudden change in temperature under high temperature, high humidity conditions. Condensation will cause deterioration of the relay insulation. 3) Freezing

Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F.

This causes problems such as sticking of movable parts or operational time lags. 4) Low temperature, low humidity environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time

### 5. M.B.B. contact relays

A small OFF time may be generated by the contact bounce during contact switching. Check the actual circuit carefully.

If the relay is dropped accidentally, check the appearance and characteristics including M.B.B. time

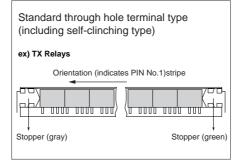
before use.

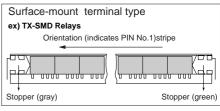
## 6. Packing style

1) Tube orientation for both standard through hole terminal type (including self-clinching type) and surface-mount terminal type.

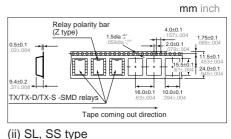
The relay is packed in a tube with the relay orientation mark on the left side, as shown in the figure below.

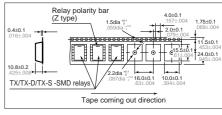
Take note of the relay orientation when mounting relays on the printed circuit board.





(2) Tape and reel packing (surfacemount terminal type) (1) Tape dimensions 1)TX/TX-D/TX-S-SMD Relays (i) SA type



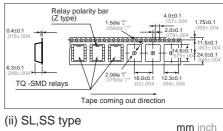


# **2TQ** -SMD Relays

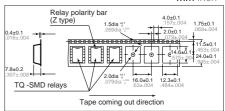
(i) SA type



mm inch

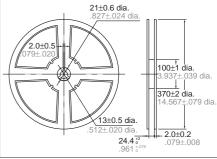




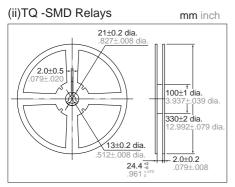


(2) Dimensions of plastic reel (i) TX/TX-D / TX-S -SMD Relays

mm inch





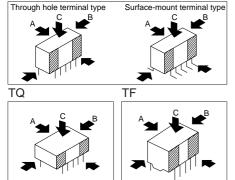


## 7. Automatic insertion

To maintain the internal function of the relay, the chucking pressure should not exceed the values below.

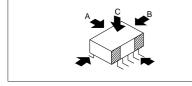
- 1) TX(-SMD)/TX-D(-SMD)/TQ/TF
- Chucking pressure in the direction A: 4.9 N {500 g} or less
- Chucking pressure in the direction B: 9.8 N {1 kg} or less
- Chucking pressure in the direction C: 9.8 N {1 kg} or less

## TX(-SMD)/TX-D(-SMD) / TX-S(-SMD)



Please chuck the <u>minimize</u> portion. Avoid chucking the center of the relay. 2) TQ-SMD

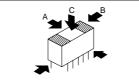
- Chucking pressure in the direction A: 9.8 N {1 kg} or less
- Chucking pressure in the direction B: 9.8 N {1 kg} or less
- Mounting pressure in the direction C: 9.8 N {1 kg} or less



Please chuck the minimum portion.

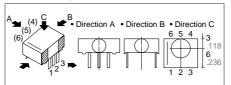
Avoid chucking the center of the relay. 3) TN

- Chucking pressure in the direction A: 9.8 N {1 kg} or less
- Chucking pressure in the direction B: 9.8 N {1 kg} or less
- Chucking pressure in the direction C: 4.9 N {500 g} or less



Please chuck the *multiplease* portion. Avoid chucking the center of the relay. 4) TK

- Chucking pressure\* in the direction A: 9.8 N {1 kg} or less
- Chucking pressure\* in the direction B: 29.4 N {3 kg} or less
- Chucking pressure\* in the direction C: 9.8 N {1 kg} or less



#### Please chuck the *mission* portion. Avoid chucking the center of the relay.

\*Value of chucking the center of the relay. \*Value of chucking pressure is shown by the value of weight pressed on the portion(4 mm dia.)

#### 8. Soldering

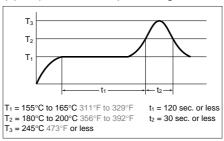
1) Preheat according to the following conditions.

Temperature	100°C 212°F or less			
Time	Within approx. 1 minute			
Time	within approx. I minute			

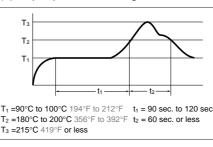
When soldering standard PC board terminals or self-clinching terminals, soldering should be done at 250°C 482°F within 5 sec.

2) When soldering surface-mount terminals, the following conditions are recommended.

(1) IR (Infrared reflow) soldering method



(2) Vapor phase soldering method



(3) Soldering iron method Tip temperature: 280°C to 300°C 536°F to 572°C

Wattage: 30 to 60 W
Soldering time: within 5 sec.
(4) Other soldering methods
Check mounting conditions before using other soldering methods (hot-air, hot plate, pulse heater, etc.).

#### Remarks

• The temperature profile indicates the temperature of the soldered terminal on the surface of the PC board. The ambient temperature may increase excessively. Check the temperature under mounting conditions.

• The conditions for the infrared reflow soldering apply when preheating using the VPS method.

#### 9. Cleaning

In automatic cleaning, cleaning with the boiling method is recommended. Avoid ultrasonic cleaning which subject the relay to high frequency vibrations. It may cause the contacts to stick.

It is recommended that a fluorinated hydrocarbon or other alcoholic solvents be used.

#### 10. Others

1) If in error the relay has been dropped, the appearance and characteristics should be checked before use without fail.

2) The cycle lifetime is defined under the standard test condition specified in the JIS\* C 5442-1986 standard (temperature 15 to 35°C 59 to 95°F, humidity 25 to 85%). Check this with the real device as it is affected by coil driving circuit, load type, activation frequency, activation phase, ambient conditions and other factors.

3) For secure operations, the voltage applied to the coil should be nominal voltage. In addition, please note that pick-up and drop-out voltage will vary according to the ambient temperature and operation conditions.

4) Latching relays are shipped from the factory in the reset state. A shock to the relay during shipping or installation may cause it to change to the set state. Therefore, it is recommended that the relay be used in a circuit which initializes the relay to the required state (set or reset) whenever the power is turned on. 5) Check the ambient conditions when storing or transporting the relays and devices containing the relays. Freezing or condensation may occur in the relay, causing functional damage. Avoid subjecting the relays to heavy loads, or strong vibration and shocks.

\*Japanese Industrial Standards